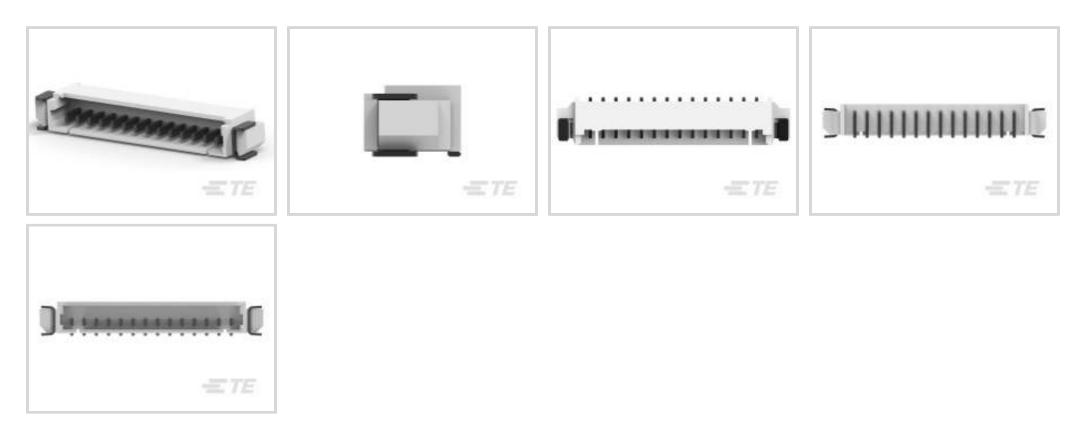
1-1734261-4 - ACTIVE

TE Internal #: 1-1734261-4 PCB Mount Header, Right Angle, Wire-to-Board, 14 Position, 1.25 mm [.049 in] Centerline, Partially Shrouded, Nickel, Surface Mount, Signal, Natural

#### View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > AMP HPI 1.25 mm Headers



Connector System: Wire-to-Board

Number of Positions: 14

Number of Rows: 1

Centerline (Pitch): 1.25 mm [.049 in ]

PCB Mount Orientation: Right Angle

All AMP HPI 1.25 mm Headers (100)

# Features

## Product Type Features

| Connector System                  | Wire-to-Board         |
|-----------------------------------|-----------------------|
| Header Type                       | Partially Shrouded    |
| Sealable                          | No                    |
| Connector & Contact Terminates To | Printed Circuit Board |
| PCB Connector Assembly Type       | PCB Mount Header      |
| Configuration Features            |                       |
| Connector Contact Load Condition  | Fully Loaded          |
| Number of Positions               | 14                    |
| Number of Rows                    | 1                     |
| PCB Mount Orientation             | Right Angle           |
| Electrical Characteristics        |                       |
| Operating Voltage                 | 100 VAC               |
| Body Features                     |                       |

PCB Mount Header, Right Angle, Wire-to-Board, 14 Position, 1.25 mm [.049 in] Centerline, Partially Shrouded, Nickel, Surface Mount, Signal, Natural



| Primary Product Color                                   | Natural                        |
|---|--------------------------------|
| Contact Features  |                                |
| PCB Contact Termination Area Plating Material Thickness | 2.54 μm[100 μin]               |
| Contact Layout  | Inline                         |
| Mating Tab Width  | .74 mm[.029 in]                |
| Mating Tab Thickness                                    | .3 mm[.012 in]                 |
| Contact Mating Area Plating Material Thickness          | 2.54 μm[100 μin]               |
| PCB Contact Termination Area Plating Material Finish    | Matte                          |
| Contact Mating Area Plating Material Finish             | Matte                          |
| PCB Contact Termination Area Plating Material           | Tin                            |
| Contact Base Material                                   | Phosphor Bronze                |
| Contact Mating Area Plating Material                    | Nickel                         |
| Contact Type  | Pin                            |
| Contact Current Rating (Max)                            | 3 A                            |
| Termination Features                                    |                                |
| Rectangular Termination Post & Tail Thickness           | .3 mm[.012 in]                 |
| Terminations per Post (Max)                             | 3                              |
| Rectangular Termination Post & Tail Width               | .35 mm[.014 in]                |
| Termination Method to Printed Circuit Board             | Surface Mount                  |
| Mechanical Attachment                                   |                                |
| Mating Alignment Type                                   | Polarization                   |
| Mating Retention  | Without                        |
| PCB Mount Retention Type                                | Solder Peg                     |
| Connector Mounting Type                                 | Board Mount                    |
| Mating Alignment  | With                           |
| PCB Mount Alignment                                     | Without                        |
| PCB Mount Retention                                     | With                           |
| Housing Features  |                                |
| Housing Material  | High Temperature Thermoplastic |
| Centerline (Pitch)                                      | 1.25 mm[.049 in]               |
| Dimensions  |                                |
| Connector Length  | 22.79 mm[.897 in]              |

PCB Mount Header, Right Angle, Wire-to-Board, 14 Position, 1.25 mm [.049 in] Centerline, Partially Shrouded, Nickel, Surface Mount, Signal, Natural



| Connector Height   | 3.45 mm[.136 in]          |
|--|---------------------------|
| Connector Width  | 4.7 mm[.185 in]           |
| Usage Conditions   |                           |
| Operating Temperature Range  | -25 – 85 °C[-13 – 185 °F] |
| Operation/Application  |                           |
| Circuit Application  | Signal                    |
| Industry Standards   |                           |
| UL Flammability Rating   | UL 94V-0                  |
| Packaging Features   |                           |
| Packaging Quantity   | 1000                      |
| Packaging Type   | Reel                      |
| <b>Product Compliance</b><br>For compliance documentation, visit the product page on TE.com> |                           |
| EU RoHS Directive 2011/65/EU   | Not Yet Reviewed          |
| EU ELV Directive 2000/53/EC  | Not Yet Reviewed          |

China RoHS 2 Directive MIIT Order No 32, 2016

No Restricted Materials Above Threshold

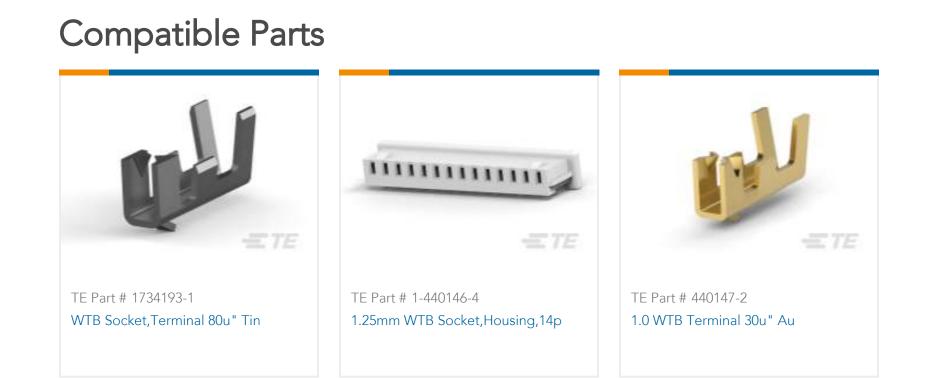
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUNE 2023<br>(235)<br>Candidate List Declared Against: JUN 2015<br>(163)<br>SVHC > Threshold:<br>Not Yet Reviewed |
|--|--|
| Halogen Content                        | Not Low Halogen - contains Br or Cl > 900<br>ppm.  |
| Solder Process Capability              | Reflow solder capable to 260°C   |

Product Compliance Disclaimer

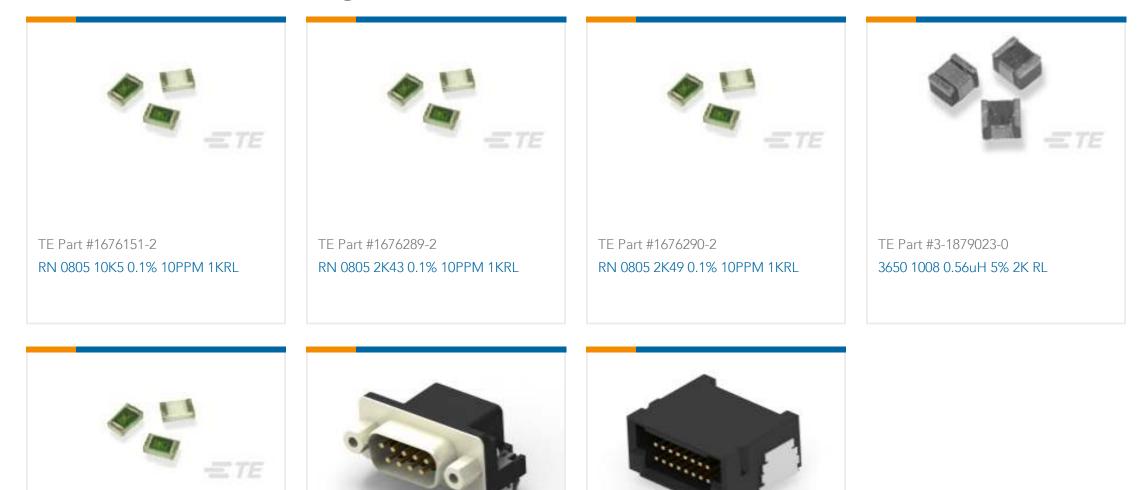
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

PCB Mount Header, Right Angle, Wire-to-Board, 14 Position, 1.25 mm [.049 in] Centerline, Partially Shrouded, Nickel, Surface Mount, Signal, Natural





# Customers Also Bought



 TE Part #1676397-2
 TE Part #2301843-2
 TE Part #294283-E

 RN 0805 61R9 0.1% 10PPM 1KRL
 AMPL PLUG HD20, R/A, 9P, B/L,4-40 S
 DRCB 0,80 16 M SMD \* 137 E009 196

 /LOCK
 GURT \*

## Documents

Product Drawings 1.25 WTB, HDR, SMT, RA, 14P

English

#### **CAD** Files

**Customer View Model** 

ENG\_CVM\_1-1734261-4\_A.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_1-1734261-4\_A.3d\_stp.zip

English

Customer View Model

ENG\_CVM\_1-1734261-4\_A.2d\_dxf.zip

English

3D PDF

PCB Mount Header, Right Angle, Wire-to-Board, 14 Position, 1.25 mm [.049 in] Centerline, Partially Shrouded, Nickel, Surface Mount, Signal, Natural



English

By downloading the CAD file I accept and agree to the  $\ensuremath{\mathsf{Terms}}\xspace$  and  $\ensuremath{\mathsf{Conditions}}\xspace$  of use.

Datasheets & Catalog Pages HPI Connectors QRG

English

Product Specifications Product Specification

English